

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE					ATTY. DOCKET NO. MI22-2393	PRIORITY SERIAL NO. 09/597,604 10/659,596	
LIST OF ART CITED BY APPLICANT (Use several sheets if necessary)					APPLICANT Fernando Gonzalez		
					PRIORITY FILING DATE June 12, 2000	PRIORITY GROUP 2818	
U.S. PATENT DOCUMENTS							
*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
T	AA	6,251,754	6/01	Kobayashi et al.			
	AB	6,245,161	6/01	Henley et al.			
	AC	5,374,581	12/94	Ichikawa et al.			
	AD	4,891,329	1/90	Reisman et al.			
	AE	6,150,031	11/00	Yonehara			
↓	AF	6,083,324	7/00	Henley et al.			
	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						
	AM						
FOREIGN PATENT DOCUMENTS							
		Document Number	Date	Country	Class	Subclass	Translation
							Yes No
	AN						
	AO						
	AP						
	AQ						
	AR						
OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)							
	AS						
	AT						
EXAMINER <i>John</i>				DATE CONSIDERED <i>7/22/04</i>			
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U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE					ATTY. DOCKET NO. MI22-2393	PRIORITY SERIAL NO. 09/972,504 <i>10/659,596</i>	
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U.S. PATENT DOCUMENTS							
*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
<i>T</i>	AA	5,298,449	03/94	Kikuchi			
<i>T</i>	AB	5,374,564	12/94	Bruel			
<i>T</i>	AC	5,855,693	01/99	Murari et al.			
<i>T</i>	AD	5,877,070	03/99	Gosele et al.			
<i>T</i>	AE	5,882,987	03/99	Srikrishnan			
<i>T</i>	AF	5,894,152	04/99	Jaso et al.			
<i>T</i>	AG	5,953,622	09/99	Lee et al.			
<i>T</i>	AH	6,004,406	12/99	Kobayashi et al.			
<i>T</i>	AI	6,309,945 B1	10/01	Sato et al.			
<i>T</i>	AJ	6,429,070 B1	08/02	Gonzalez et al.			
<i>T</i>	AK	6,384,439 B1	05/02	Walker			
<i>T</i>		6,423,992 B2	07/02	Fukuda, et al.			
<i>T</i>	AL	5,998,847	12/99	Assaderaghi, et al.			
FOREIGN PATENT DOCUMENTS							
		Document Number	Date	Country	Class	Subclass	Translation
							Yes No
	AM						
	AN						
	AO						
	AP						
	AQ						
OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)							
<i>T</i>	AR		Gösele, U. et al., "Semiconductor Wafer Bonding: Science, Technology, and Applications", Electrochemical Society Proceedings				
			Vol. 97-36, (©1998), pp. 400-425, 436-445.				
	AS						
EXAMINER	<i>Thao</i>		DATE CONSIDERED			<i>7/22/04</i>	
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